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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:)
ERRATICO)
Serial No. 09/899,573) Examiner: J. Mondt
Confirmation No. 1615) Art Unit: 2826
Filing Date: July 5, 2001)
For: INTEGRATED STRUCTURE)

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AMENDMENT

Director, U.S. Patent and Trademark Office
Washington, D.C. 20231

Sir:

Responsive to the Office Action of April 22, 2002,
please enter the amendments and remarks set out below.

In the Claims:

Please amend Claims 12, 17, and 22 as follows:

12. (Amended) An integrated structure comprising:
a substrate having a first conductivity type;
an epitaxial layer on said substrate and having the
first conductivity type and a conductivity less than a
conductivity of said substrate;
first and second regions in said epitaxial layer
each having a second conductivity type opposite the first
conductivity type, said first and second regions extending
from a surface of said epitaxial layer opposite said substrate
into said epitaxial layer to form respective first and a
second junctions therewith; and
an isolating element positioned between said first
and said second regions and extending from the surface of said
epitaxial layer at least as far as a top surface of said
substrate for reducing an injection of current through said